

THERMAL SYSTEMS





Specialized in your needs



High-quality engineering

20 years Know-How

Vacuum Drying Systems ○

Pallet Drying Systems

Hot Function Test Systems









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Example: Maeander transport (top view)

Drying Systems for assembly groups

RDS



Drying and

Hardening



	Heating Length	Heating Zones	IR-Heaters	Passage Height
RDS 2100	2100	4	possible per zone	± 100 mm
RDS 2600	2600	5	possible per zone	± 100 mm
RDS 3200	3200	7	possible per zone	± 100 mm
RDS 4800	4800	9	possible per zone	± 100 mm
RDS 5600	5600	10	possible per zone	± 100 mm

Application areas

- Chip on Board encapsulation (Globe - top)
- Chip Scale Packaging
- Flip Chip Underfill
- Cavity fill for BGA packages etc.
- Burn-in of resistive pastes in the hybrid production

Drying Systems for end user devices

Circulating Drying System

Drying System with automatic loading and unloading handling.





Throughput Drying System

Drying System with automatic loading and unloading handling at the inlet and the outlet.





Grab and work-piece carriers are designed according to the product. System dimensioning follows process parameters and throughput requirements of our customers.

Flexiblity with System!



Solutions for manual working places



In-/Out-System

e.g. for curing of sealing compounds with long cable connectors and connectors which can not be exposed to thermal stress.



Paternoster-Preheating-Oven

between two manual working places.

Pallet Magazine Drying

Example 1:

High parts throughput for small paring the low overall height and opti accessability.



Vacuum Systems





Vacuum Drying System

As Batch System with rack loading for high throughput of small parts, e.g. sensors.

Vacuum High Temperature Drying System

As Batch System with rack loading for high throughput. The high temperature soldering process takes place under forming gas at over 400 °C and the shaping of solder points under definied Temperature-Time-Course with changing atmosphere.



Example 2:

throughput for large-size sheets.

Hot Function Test



Integrated test system

In this system the parts are heated to the test temperature and transported to the test station which is integrated into the last heating zone. In this way the function test takes place under reproducible temperatures



Downline test system

In this system the parts are heated to the test temperature and transported on demand out of the oven into the downline test station by means of quic transport. This procedure is applied t big multi function test benches.







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Transport Systems

The variety of the applications is reflected in the different versions of transport systems. Pin chain conveyors with and without accumulating rollers, mesh belts, different workpiece carriers, pendular work-piece carriers, racks, etc.

are applied in the Circular Drying Systems or in the equipment of Batch operation. For the integration of Rehm systems in already existing lines we supply you with the necessary handling systems.

Roller Chain Transport



Pin Chain Conveyor



multi-track



Work-piece carrier transport

single lane/multi-track



Basket Transport for small parts



Shuttle transport



Circuit work-piece carrier transport



Maeander transport





Thermal System Solutions

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Innovation for success!

Rehm Thermal Systems is an international supplier of soldering systems and thermal system solutions for the electronics industry. We supply custom tailored solutions for a great variety of applications in modern electronics manufacturing with high precision, innovative, reliable systems and intelligent software.

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